High-Mobility Few-Layer Graphene Field Effect Transistors Fabricated

on Epitaxial Ferroelectric Gate Oxides

X. $Hong^1$, A. Posadas², K. Zou¹, C. H. Ahn² and J. Zhu^{1,*}

¹Department of Physics, The Pennsylvania State University, University Park, PA 16802

²Department of Applied Physics, Yale University, New Haven, CT 06520

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1. Characterizations of Pb(Zr_{0.2}Ti_{0.8})O₃ films

The crystalline quality of the PZT thin films is characterized with x-ray diffraction (XRD). Figure S1 shows the θ -2 θ measurement of a typical 300 nm Pb(Zr,Ti)O₃ (PZT) film grown epitaxially on SrTiO₃ (STO) substrate. Only 00*n* (*n* =1, 2, etc.) peaks for PZT and STO are detected, showing a *c*-axis oriented film growth, with the polarization *P* pointing normal to the surface (characterized with piezoresponse force microscopy, see below). The *c*-axis lattice constant is ~4.15 Å, consistent with the value of a partially relaxed film. The rocking curve of the 001 peak has a full-width-half-maximum of 0.04°, close to the instrumental resolution, reflecting very high crystallinity.



Fig. S1 X-ray θ -2 θ measurement of a 300 nm PZT film grown on a SrTiO₃ substrate. The double-peak feature is due to the $k_{\alpha 1}$ and $k_{\alpha 2}$ x-rays.

We have chosen film thickness of d = 300 and 400 nm to enhance the optical visibility of graphene through modeling described in Ref. [1]. AC voltages and voltage pulses of different polarity and magnitude are applied to the AFM tip scanning in contact with the PZT surface to perform piezoresponse force microscopy (PFM) [2]. Negative voltage pulses > 8 V are needed to switch the polarization of 400 nm as-grown films. We conclude that *P* uniformly points into the surface, as expected from the growth procedure. The direction of *P* remained unchanged throughout the current study.

2. Substrate preparation before the exfoliation of graphene

Prior to graphene exfoliation, PZT and SiO_2 substrates are sonicated in acetone for 20 minutes followed by an IPA rinse (1 min) and drying under a stream of dry N₂ gas. They are subsequently baked at 120°C for 5 minutes before the exfoliation of graphene.

3. The band structure of FLG

We employ a simply two-band model to estimate the band overlap energy $\delta \varepsilon$ and the densities of electrons and holes in the two-carrier regime near the charge neutrality point of our device, using band parameters determined by Novoselov *et al.* for FLG in Ref. [3] and supporting materials. Measurements there indicate a single electron band with an effective mass $m_{e}^{*} = 0.06m_{0}$ and two hole bands with a heavy hole mass $m_{h}^{h} = 0.1m_{0}$ and a light hole mass $m_{h}^{1} = 0.03m_{0}$. Note these effective mass values are close to those found in bulk graphite: $m_{e}^{*} = (0.056\pm0.003) m_{0}$ and $m_{h}^{*} = (0.084\pm0.005) m_{0}$ as well [4]. Without knowing the exact offset between the two hole bands, we simplify the estimate by ignoring the light holes, which likely account for less than 25% of the hole population due to the mass ratio. The densities of states of electrons and holes are then given by $\frac{2m_{e,h}^{*}}{\pi h^{2}}$, where we have included the 4-fold degeneracy due to valley and spin [3].

The density of electrons and holes in the band overlap regime of the FLG is calculated as follows:

$$n_{e,h} = n_{e,h}^{0} \pm \frac{\alpha V_{g} m_{e,h}^{*}}{(m_{e}^{*} + m_{h}^{*})} \qquad (``+`` for electron and ``-`' for hole)$$
(S1),

where $n_{e,h}^{0}$ represents the electron/hole density at the charge neutrality point. At the threshold voltage $V_{g}^{T} = 1.1$ V (Fig. 2(b)) where the hole band is completely filled, $n_{e} = 1.5 \times 10^{12}$ /cm² and $n_{h} = 0$. Using Eq. S1, we estimate that $n_{e}^{0} = n_{h}^{0} \sim 9 \times 10^{11}$ /cm² at the charge neutrality point. This translates into a band overlap of $\delta \varepsilon \sim 30$ meV between the electron and hole bands. Alternatively, we determine $\delta \varepsilon$ by fitting $\rho(T)$ at the charge neutrality point to the thermal excitation model described in Ref. [3] and obtain $\delta \varepsilon \sim 27$

meV. The good agreement between these two methods and with theory [5] gave us confidence in these estimates. However we emphasize that the central results of our paper are derived from the electron-only regime ($V_g > V_g^T$) and do not rely on an accurate knowledge of the band structure in the two-carrier regime.

4. Dielectric constant measurements of PZT

We deduce the dielectric constant κ of PZT substrate by Hall and low-frequency capacitance measurements independently. Figure S2 shows hole densities extracted from Hall measurements as a function of the backgate voltage V_g in three different devices placed on the same PZT substrate, including the device shown in Fig. 2. We determine the charge injection rate $\alpha = (1.35\pm0.05)\times10^{12} \text{ cm}^{-2}/V_g(V)$ using Eq. (2) in the single carrier (hole) regime, and calculate $\kappa \approx 100$ using a parallel-plate capacitor model.



Fig. S2 Hole density *n* vs. backgate voltage V_g taken on three devices (squares, circles and triangles) on the same PZT substrate. The fit (blue dashed line) corresponds to a charge injection rate of 1.35×10^{12} cm⁻²/V. V_g is shifted to align the charge neutrality point at $V_g = 0$ V as described in the text. Inset: Hall resistance R_{xy} vs. perpendicular magnetic field for $n = 4.6 \times 10^{12}$ /cm².

We also determine κ directly through low-frequency (20-1000 Hz) capacitance measurements. Capacitors with varying areas are measured to eliminate the effect of parasitic capacitances. We calculate the area of a capacitor from the mask design and estimate $\kappa \approx 120$ from these measurements.

5. $\rho(V_g)$ fitting inside the band overlap regime

We fit our low- $T \rho (V_g)$ data to Eqs. (1) and (3) within the band overlap regime, using effective masses of $m_e^* = 0.06m_0$ and $m_h^* = 0.1m_0$. A different set of mass values may lead to a different band overlap $\delta \varepsilon$ and affects the value of the exponent β in Eq. (3). For example, $\delta \varepsilon \sim 32$ meV and $\beta \sim 1.0$, or $\delta \varepsilon \sim 27$ meV and $\beta \sim 0.8$ can fit the same data equally well as the values used in the text ($\delta \varepsilon \sim 30$ meV and $\beta \sim 0.9$). Beyond this energy range of $\delta \varepsilon$ (27-32 meV), a power-law *n*-dependence of mobility no longer describes the data well. The above analysis shows that although the precise value of β depends on $\delta \varepsilon$ and hence the detailed understanding of the band structure of FLG, the power-law *n*-dependence seems to be robust.

This *n*-dependence of mobility is also supported by the measurements of the Hall coefficient $R_{\rm H}$. Within the band overlap regime, R_H exhibits the characteristics of a two-carrier system described by Eq. S2:

$$R_{H} = \frac{n_{h}\mu_{h}^{2} - n_{e}\mu_{e}^{2}}{e(n_{h}\mu_{h} + n_{e}\mu_{e})^{2}}$$
(S2).

At high $|V_g|$, the system becomes a purely electron or hole gas and $R_{\rm H}$ reads:

$$R_{H} = \frac{1}{en_{e,h}} = \frac{1}{e\alpha(V_{g} - V_{g}^{0})}$$
(S3),

Where for PZT-gated samples $\alpha = 1.35 \times 10^{12} \text{ cm}^{-2}/\text{V}$ and V_g^0 is offset to 0 V. Figure S3 plots R_H vs. V_g of the FLG shown in Fig. 2, together with three fitting curves. R_H calculated using Eq. (S2) with $n_{e,h}$ given by Eq. (S1) and $\mu_{e,h}$ given by Eq. (3) with $\beta = 0.9$ and r = 0.6 (red) produce an excellent agreement with the data. Calculations based on a

constant mobility $\mu_h = \mu_e = \text{const.}$ (green), or an *n*-dependent but symmetric electron and hole mobility $\mu_h = \mu_e \sim n^{0.9}$ (blue) clearly do not fit the data.



Fig. S3 Hall coefficient $R_{\rm H}$ vs. $V_{\rm g}$ at 10 K with three calculated curves. Curve A (red): $\mu_{\rm e,h} \sim n_{\rm e,h}^{0.9}$, $\mu_{\rm h}/\mu_{\rm e} = 0.6$ (Eq. 3 of text). Curve B (green): $\mu_{\rm h} = \mu_{\rm e} = \text{const.}$ Curve C (blue): $\mu_{\rm h} = \mu_{\rm e} \sim n^{0.9}$. The charge injection rate $\alpha = 1.35 \times 10^{12} \text{ cm}^{-2}/\text{V}$.

6. The deformation potential of LA phonons in graphene

In Eq. (4), we assume an unscreened deformation potential D for LA phonons. Studies in GaAs show that neglecting the dielectric screening may result in an underestimate of the deformation potential [6]. The detailed *T*-dependence in the BG regime from a sample of yet higher mobility is required to determine the effect of screening. This analysis is beyond the scope of the present paper.

7. Resistivity and Hall measurements of a SiO₂-gated FLG

To compare the performance of PZT and SiO₂ substrates, we fabricate a FLG-FET of the same thickness (2.4 nm) on 300 nm SiO₂ following identical preparation steps. Figure S4 shows $\rho(V_g)$ of the SiO₂-gated FLG at selected temperatures. The charge neutrality point occurs at $V_g^0 = -15.5$ V due to unintentional chemical doping. We find the charge injection rate of the backgate to be $\alpha = 7.0 \times 10^{10}$ cm⁻²/V, in excellent agreement with calculations and experimental values from other graphene FETs made from the same set of wafers. We determine $\mu(T)$ using Eq. (2) at electron density $n = 2.4 \times 10^{12}$ cm⁻² ($V_g = 19$ V). The results are plotted in Fig. 4 as open triangles. The mobility μ is approximately 14,000 cm²/Vs and shows a very weak *T*-dependence. These findings are in good agreement with what has been reported in the literature [3].



Fig. S4 $\rho(V_g)$ of the SiO₂-gated FLG (2.4 nm) at selected temperatures 4 K < T < 300 K. The charge neutrality point $V_g^0 = -15.5$ V. The arrow marks $V_g = 19$ V corresponding to $n = 2.4 \times 10^{12}$ cm⁻², where we determine the mobility plotted in Fig. 4.

Figure S5 shows R_H vs. V_g in this FLG. The band overlap, electron-only and holeonly regimes are all clearly visible. Red solid lines are calculated from Eq. (S3) using $\alpha = 7.0 \times 10^{10} \text{ cm}^{-2}/\text{V}$ and $V_g^0 = -15.5 \text{ V}$. The transition voltage to the electron-only regime (~ 2 V) is in good agreement with that of the PZT-gated FLG, indicated by an arrow.



Fig. S5 Hall coefficient $R_{\rm H}$ vs. $V_{\rm g}$ (T = 4 K) of the SiO₂-gated FLG. Red solid lines are calculated using Eq. S3 and correspond to electron- and hole-only regime, respectively. The blue arrow indicates the equivalent voltage of the band edge observed in the PZT-gated FLG of the same thickness. The cross marks (-15.5V, 0 Ω /T).

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